

80V, 333A, 1.3m Ω N-channel Power SGT MOSFET

JMSH0802PTL

Features

- $\bullet \;\;$ Excellent $R_{\text{DS(ON)}}$ and Low Gate Charge
- 100% UIS Tested
- 100% ΔVds Tested
- Halogen-free; RoHS-compliant

Applications

- Load Switch
- PWM Application
- Power Management

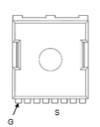
Product Summary

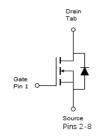
Parameters	Value	Unit		
V_{DSS}	80	٧		
$V_{GS(th)_Typ}$	2.9	٧		
$I_D(@V_{GS}=10V)$	333	Α		
$R_{DS(ON)_Typ}(@V_{GS}=10V$	1.3	mΩ		











PowerJE®10x12

Pin Assignment

Schematic Diagram

Ordering Information

Device	Device Marking		Form	Package	Reel(pcs)	Per Carton (pcs)
JMSH0802PTL	SH0802P	1	Tape&Reel	PowerJE®10x12	2000	10000

Absolute Maximum Ratings (@ $T_C = 25$ °C unless otherwise specified)

Symbol	Parameter		Value	Unit	
V_{DS}	Drain-to-Source Voltage		80	V	
V_{GS}	Gate-to-Source Voltage		±20	V	
I _D Continuous Drain Current	$T_C = 25^{\circ}C$	333	^		
	Continuous Drain Current	$T_C = 100$ °C	211	A	
I_{DM}	Pulsed Drain Current (1)		Refer to Fig.4	Α	
E _{AS}	Single Pulsed Avalanche Energy (2)		1765	mJ	
P _D	POWAR Discination	$T_C = 25^{\circ}C$	357	· w	
		$T_C = 100$ °C	143		
T_{J}, T_{STG}	Junction & Storage Temperature Range		-55 to 150	°C	

Thermal Characteristics

Symbol	Parameter	Max	Unit
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient ⁽³⁾	35	°C/W
$R_{\theta JC}$	Thermal Resistance, Junction to Case	0.35	C/VV



Electrical Characteristics (T_J = 25°C unless otherwise specified)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Off Cha	racteristics					
$V_{(BR)DSS}$	Drain-Source Breakdown Voltage	$I_D = 250 \mu A, V_{GS} = 0 V$	80	-	-	V
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 64V, V_{GS} = 0V$	-	-	1.0	μА
I _{GSS}	Gate-Body Leakage Current	$V_{DS} = 0V, V_{GS} = \pm 20V$	-	-	±100	nA
On Cha	racteristics			•		•
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	2.0	2.9	4.1	V
R _{DS(ON)}	Static Drain-Source ON-Resistance ⁽⁴⁾	$V_{GS} = 10V, I_D = 20A$	-	1.3	1.8	mΩ
Dynami	ic Characteristics					
R_g	Gate Resistance	f = 1MHz	-	0.4	-	Ω
C_{iss}	Input Capacitance	., ., ., ., .,	9019	12627	17047	pF
C_{oss}	Output Capacitance	$V_{GS} = 0V, V_{DS} = 40V,$ $f = 1MHz$	2423	3392	4579	pF
C_{rss}	Reverse Transfer Capacitance		55	77	103	pF
Q_g	Total Gate Charge		136	190	257	nC
Q_{gs}	Gate Source Charge	$V_{GS} = 0 \text{ to } 10V$ $V_{DS} = 40V, I_{D} = 20A$	43	60	81	nC
Q_{gd}	Gate Drain("Miller") Charge	V DS - 40 V, ID - 20/1	29	40	54	nC
	ing Characteristics	1			1	Ι
t _{d(on)}	Turn-On DelayTime	4	-	39	-	ns
t _r	Turn-On Rise Time	$V_{GS} = 10V, V_{DD} = 40V$	-	31	-	ns
t _{d(off)}	Turn-Off DelayTime	$I_D=20A, R_{GEN}=3\Omega$	-	78	-	ns
t _f	Turn-Off Fall Time		-	33	-	ns
Body D	iode Characteristics			_	ı	-
I _S	Maximum Continuous Body Diode Forward Current		-	-	333	А
I _{SM}	Maximum Pulsed Body Diode Forward Current		-	-	1333	Α
V_{SD}	Body Diode Forward Voltage	$V_{GS} = 0V, I_{S} = 20A$	-		1.2	V
trr	Body Diode Reverse Recovery Time	I _F = 20A, di/dt = 100A/us	80	112	151	ns
Qrr	Body Diode Reverse Recovery Charge	$rac{1}{1}$ $rac{1}$ $rac{1}{1}$ $rac{1}{1}$ $rac{1}$ $rac{1}{1}$ $rac{1}$ $rac{1}$ $rac{1}{1}$ $rac{1}$ r	-	318	-	nC

Notes:

^{1.} Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature.

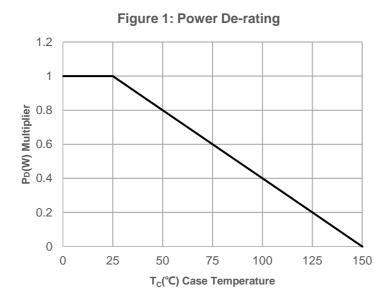
 $^{2.\;}E_{AS}\;condition:\;Starting\;T_J=25C,\;V_{DD}=40V,\;V_{GS}=10V,\;R_G=25ohm,\;L=3mH,\;I_{AS}=34.3A,\;V_{DD}=0V\;during\;time\;in\;avalanche.$

^{3.} $R_{\theta JA}$ is measured with the device mounted on a 1inch² pad of 2oz copper FR4 PCB.

^{4.} Pulse Test: Pulse Width≤300µs, Duty Cycle≤0.5%.



Typical Performance Characteristics



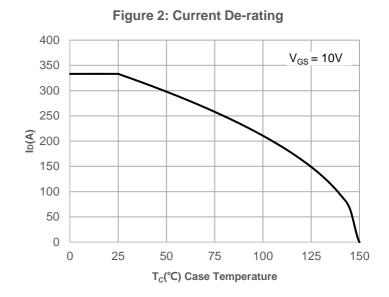
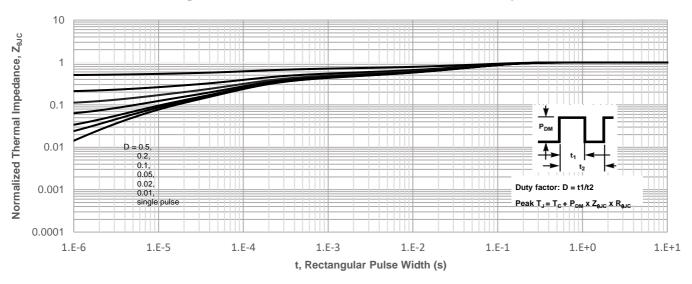
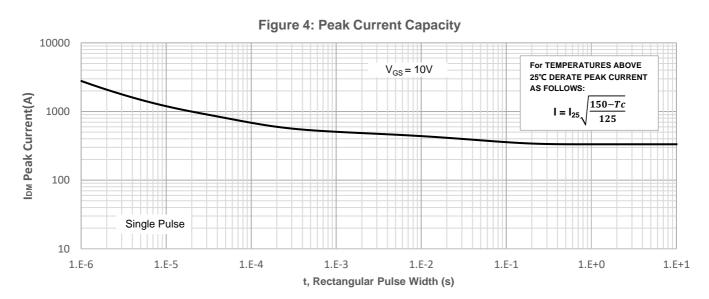


Figure 3: Normalized Maximum Transient Thermal Impedance





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Typical Performance Characteristics

Figure 5: Output Characteristics 200 $V_{GS} = 10V, 8V, 6V$ $V_{GS} = 5.5V$ 160 120 $V_{GS} = 5.0V$ 80 40 $V_{GS} = 4.5V$ $V_{GS} = 4.0V$ 0 0 2 3 4

Figure 6: Typical Transfer Characteristics

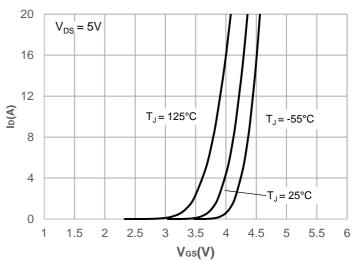


Figure 7: On-resistance vs. Drain Current

V_{DS}(V)

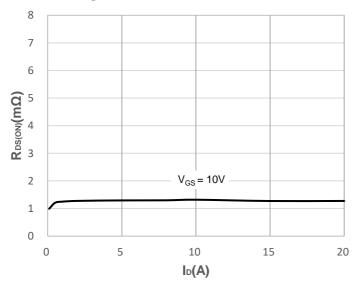


Figure 8: Body Diode Characteristics

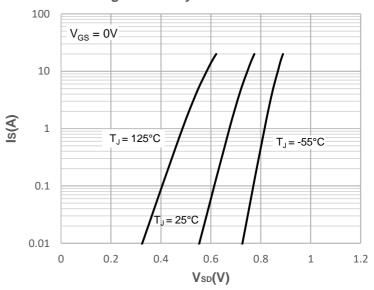


Figure 9: Gate Charge Characteristics

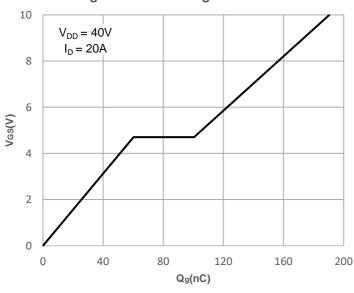
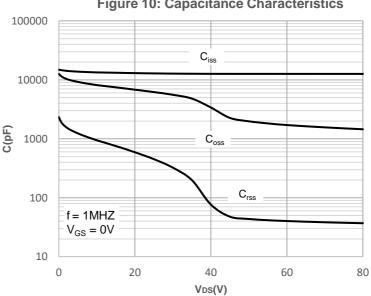


Figure 10: Capacitance Characteristics



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Typical Performance Characteristics

Figure 11: Normalized Breakdown voltage vs. Junction Temperature

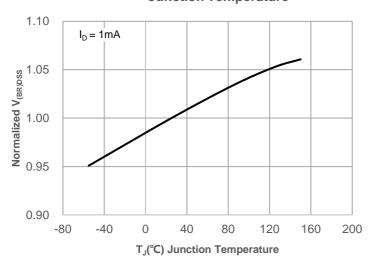


Figure 13: Normalized Threshold Voltage vs. Junction Temperature

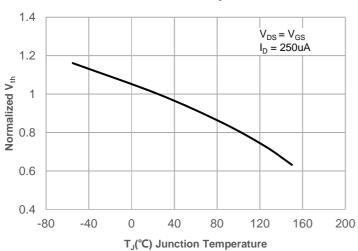


Figure 15: Maximum Safe Operating Area

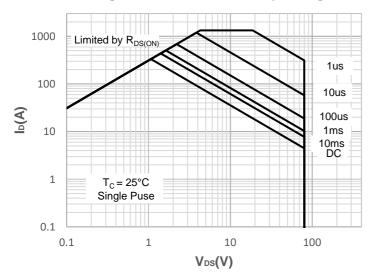
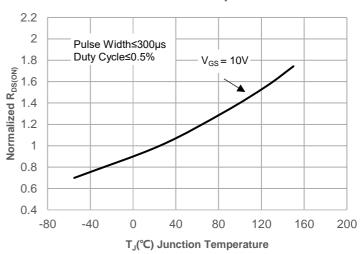
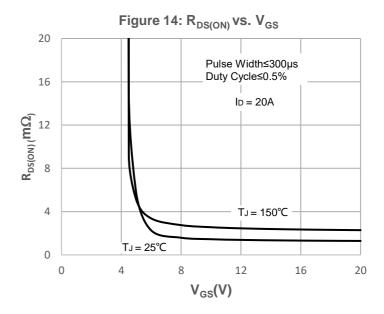


Figure 12: Normalized on Resistance vs. Junction Temperature







Test Circuit

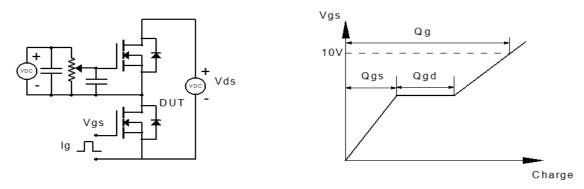


Figure 1: Gate Charge Test Circuit & Waveform

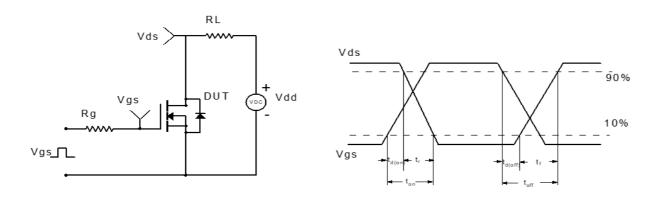


Figure 2: Resistive Switching Test Circuit & Waveform

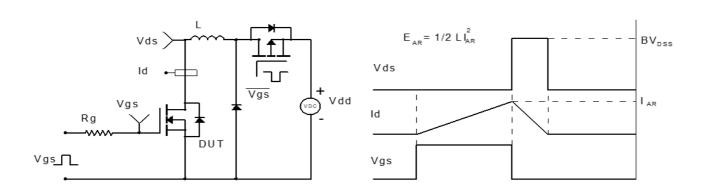


Figure 3: Unclamped Inductive Switching Test Circuit& Waveform

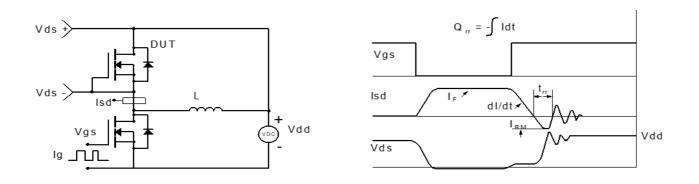
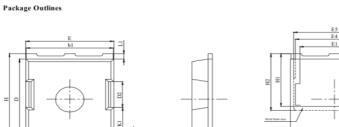


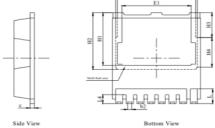
Figure 4: Diode Recovery Test Circuit & Waveform

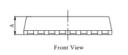
M



Package Mechanical Data(PowerJE®10x12)







on and tolerance per ASME Y14.5M, 1994

mension and tolerance per ASME 114.5M, 1994. I I dimensions in millimeter. mensions do not include burrs or mold flash. Mold flash or rrs does not exceed 0.150mm.

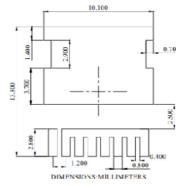
DIM. MIN NOM MAX Α 2.20 2.30 2.50 b 0.70 0.80 0.90 bl 9.70 9.80 9.90 b2 0.42 0.46 0.50 C 0.40 0.50 0.65 D 10.28 10.38 10.58 D2 3.30 9.70 10.10 Ε 9.90 E1 7.80 E4 8.80 E5 9.20 1.20(BSC) e 11.48 11.68 11.88 Н HI 6.55 6.75 6.85 H2 7.30 3.20 H3 Н4 3.80 K1 4.18 1.70 2.10 L 1.90 L1 0.70 L2 0.60 1.00 1.30

L4

MILLIMETER

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Recommended Soldering Footprin



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